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THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:
Hsueh-Chang Wu, et al.

Serial No.: 10/753,253

Filed: January 5, 2004

For: RAPID TEMPERATURE
COMPENSATION MODULE FOR
SEMICONDUCTOR TOOL

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Attorney Docket No.:
2003-0440 / 24061.81

Customer No. 42717

Group Art Unit: 3742

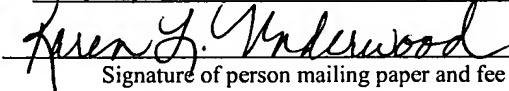
Examiner: Shawntina T. Fuqua

Confirmation No.: 6691

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RESPONSE UNDER 37 C.F.R. §1.111

This Response is a reply to the Office Action mailed on July 28, 2005. (Please see the
pages that follow).